To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

MOS FIELD EFFECT TRANSISTOR

μPA1716

SWITCHING
P-CHANNEL POWER MOS FET
INDUSTRIAL USE

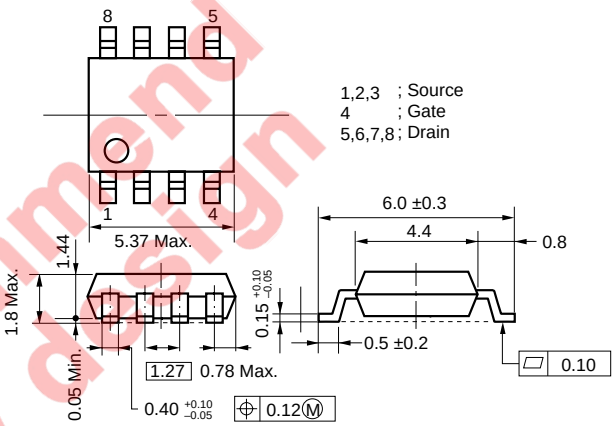
DESCRIPTION

This product is P-Channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

FEATURES

- Low on-resistance
  $R_{DS(on)1}$ = 12.5 mΩ TYP. (V_{GS} = –10 V, I_D = –4 A)
  $R_{DS(on)2}$ = 17.0 mΩ TYP. (V_{GS} = –4.5 V, I_D = –4 A)
  $R_{DS(on)3}$ = 19.0 mΩ TYP. (V_{GS} = –4.0 V, I_D = –4 A)
- Low C_{iss} : C_{iss} = 2100 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

PACKAGE DRAWING (Unit : mm)



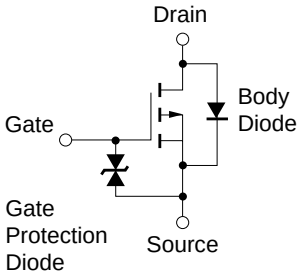
ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1716G	Power SOP8

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, All terminals are connected.)

Drain to Source Voltage (V_{GS} = 0 V)	V_{DSS}	–30	V
Gate to Source Voltage (V_{DS} = 0 V)	V_{GSS}	∓20	V
Drain Current (DC)	$I_{D(DC)}$	∓8	A
Drain Current (pulse) Note1	$I_{D(pulse)}$	∓32	A
Total Power Dissipation (T_A = 25°C) Note2	P_T	2.0	W
Channel Temperature	T_{ch}	150	°C
Storage Temperature	T_{stg}	–55 to +150	°C

EQUIVARENT CIRCUIT



Notes 1. PW ≤ 10 μs, Duty Cycle ≤ 1 %

2. Mounted on ceramic substrate of 1200 mm^2 x 1.0 mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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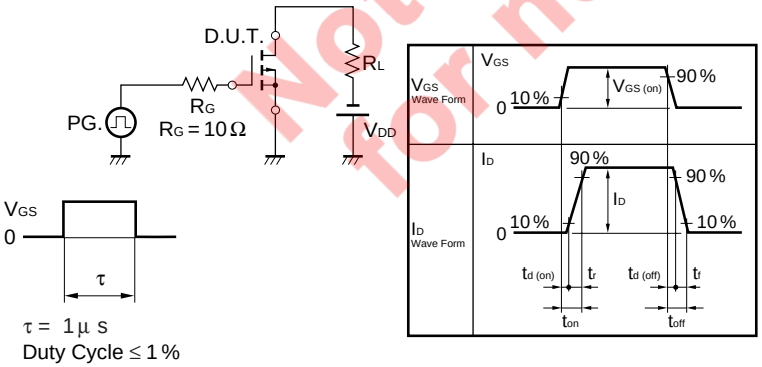
Date Published March 1999 NS CP(K)
Printed in Japan

ELECTRICAL CHARACTERISTICS (T_A = 25 °C, All terminals are connected.)

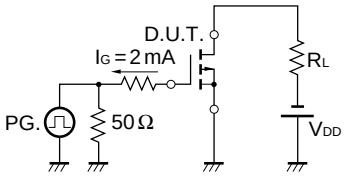
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	$R_{DS(on)1}$	V_{GS} = –10 V, I_D = –4.0 A		12.5	16	mΩ
	$R_{DS(on)2}$	V_{GS} = –4.5 V, I_D = –4.0 A		17	23	mΩ
	$R_{DS(on)3}$	V_{GS} = –4.0 V, I_D = –4.0 A		19	26	mΩ
Gate to Source Cut-off Voltage	$V_{GS(off)}$	V_{DS} = –10 V, I_D = –1 mA	–1.0	–1.6	–2.5	V
Forward Transfer Admittance	$\|y_{fs}\|$	V_{DS} = –10 V, I_D = –4.0 A	7	14		S
Drain Leakage Current	I_{DSS}	V_{DS} = –30 V, V_{GS} = 0 V			–1	μA
Gate to Source Leakage Current	I_{GSS}	V_{GS} = ∓20 V, V_{DS} = 0 V			∓10	μA
Input Capacitance	C_{iss}	V_{DS} = –10 V V_{GS} = 0 V f = 1 MHz		2100		pF
Output Capacitance	C_{oss}			700		pF
Reverse Transfer Capacitance	C_{rss}			300		pF
Turn-on Delay Time	$t_{d(on)}$	I_D = –4.0 A $V_{GS(on)}$ = –10 V V_{DD} = –15 V R_G = 10 Ω		30		ns
Rise Time	t_r			150		ns
Turn-off Delay Time	$t_{d(off)}$			120		ns
Fall Time	t_f			76		ns
Total Gate Charge	Q_G	I_D = –8.0 A V_{DD} = –24 V V_{GS} = –10 V		40		nC
Gate to Source Charge	Q_{GS}			6		nC
Gate to Drain Charge	Q_{GD}			10		nC
Body Diode Forward Voltage	$V_{F(S-D)}$	I_F = 8.0 A, V_{GS} = 0 V		0.8		V
Reverse Recovery Time	t_{rr}	I_F = 8.0 A, V_{GS} = 0 V di/dt = 100 A/μs		45		ns
Reverse Recovery Charge	Q_{rr}			33		nC

TEST CIRCUIT 1 SWITCHING TIME



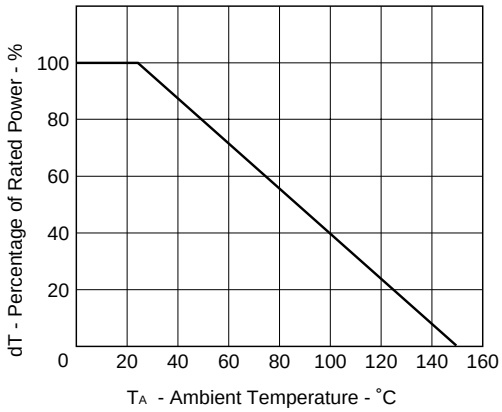
τ = 1 μs
Duty Cycle ≤ 1 %

TEST CIRCUIT 2 GATE CHARGE

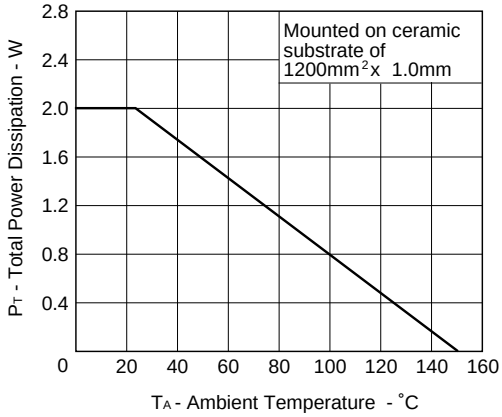


TYPICAL CHARACTERISTICS (T_A = 25 °C)

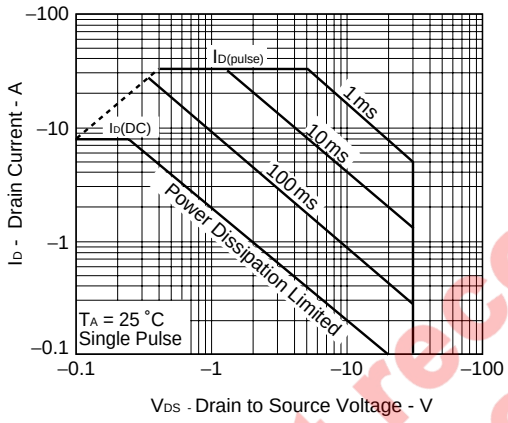
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE

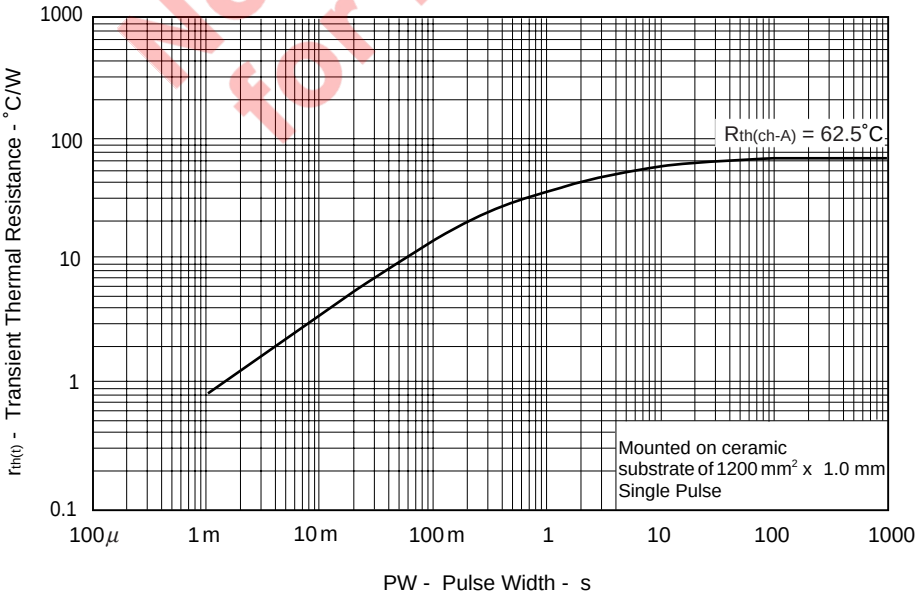


FORWARD BIAS SAFE OPERATING AREA

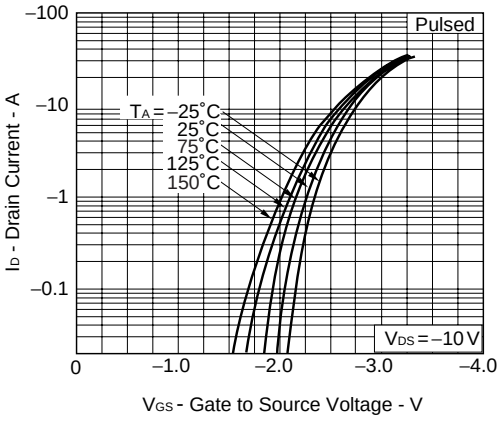


Remark Mounted on ceramic substrate of 1200 mm^2 x 1.0 mm

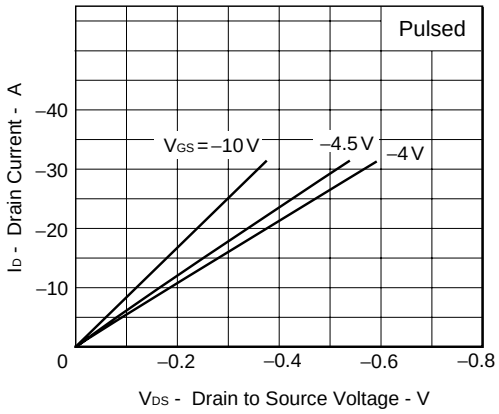
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



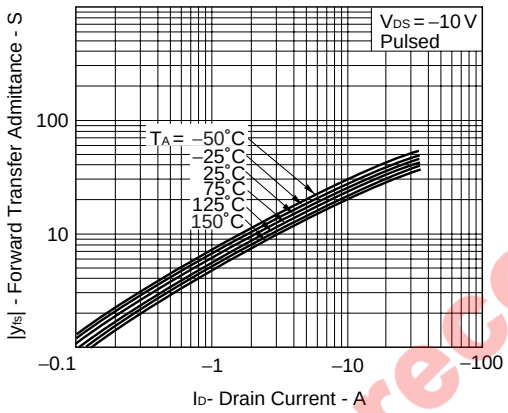
FORWARD TRANSFER CHARACTERISTICS



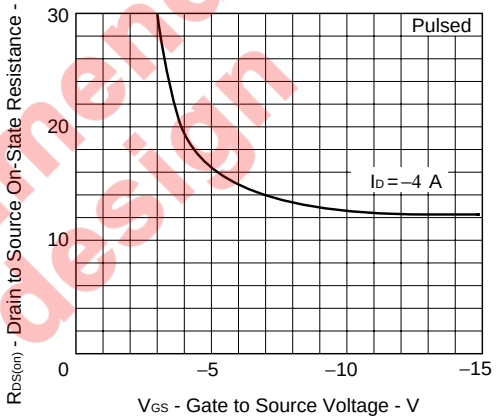
DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE



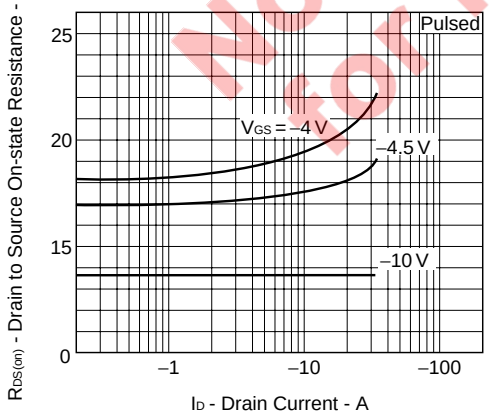
FORWARD TRANSFER ADMITTANCE vs.
DRAIN CURRENT



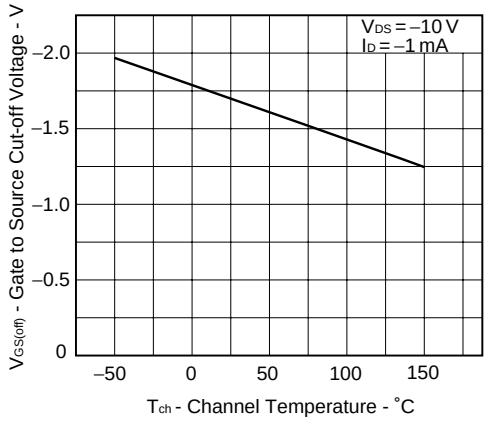
DRAIN TO SOURCE ON-STATE RESISTANCE vs.
GATE TO SOURCE VOLTAGE



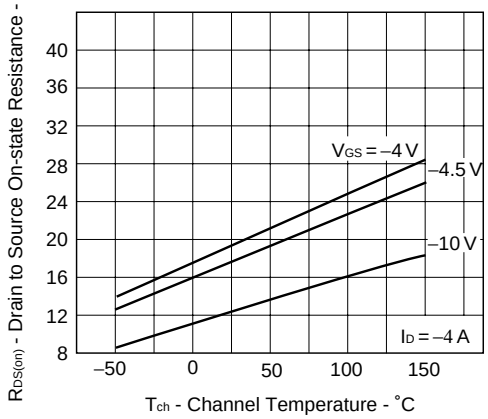
DRAIN TO SOURCE ON-STATE
RESISTANCE vs. DRAIN CURRENT



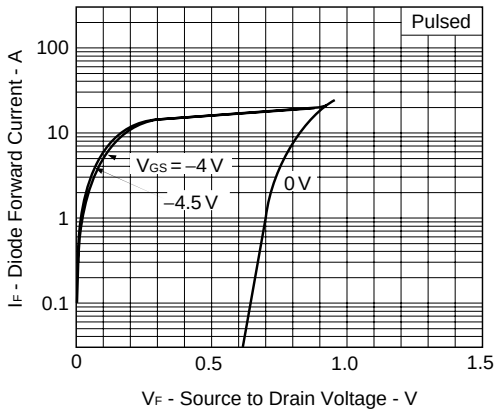
GATE TO SOURCE CUTOFF VOLTAGE vs.
CHANNEL TEMPERATURE



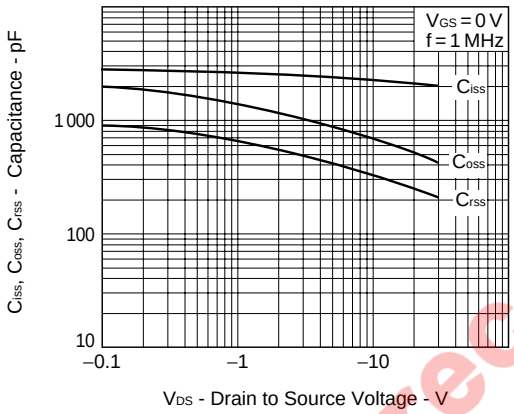
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



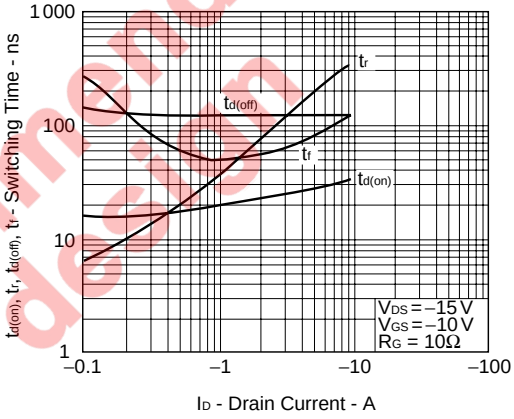
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



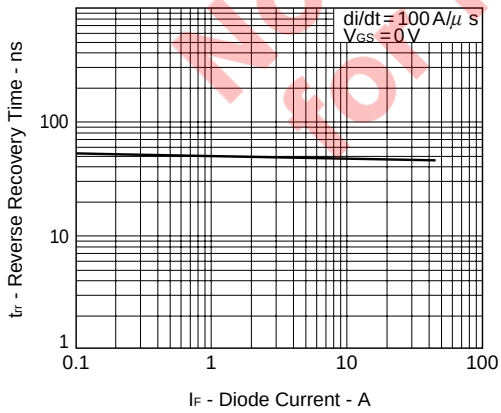
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



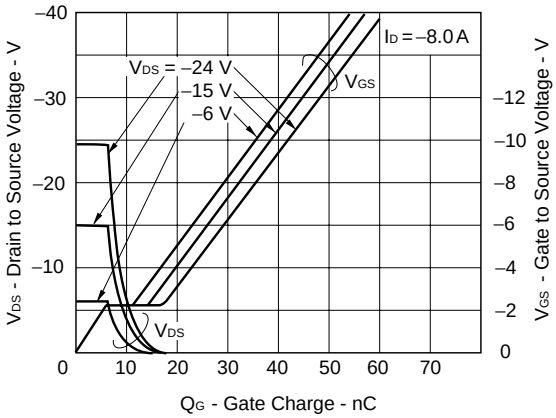
SWITCHING CHARACTERISTICS



REVERSE RECOVERY TIME vs. DIODE CURRENT



DYNAMIC INPUT/OUTPUT CHARACTERISTICS



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